

Maximum Ratings (@T_A = 25°C, unless otherwise specified.)

Characteristic	Symbol	BAS19	BAS20	BAS21	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage	V _{RWM} V _R	100	150	200	V
RMS Reverse Voltage	V _{R(RMS)}	71	106	141	V
Forward Continuous Current (Note 6)	I _{FM}	400			mA
Average Rectified Output Current (Note 6)	I _O	200			mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s	I _{FSM}	2.5 0.5			A
Repetitive Peak Forward Surge Current (Note 6)	I _{FRM}	625			mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	250	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = 25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7) BAS19 BAS20 BAS21	V _{(BR)R}	120 200 250	—	V	I _R = 100μA
Forward Voltage	V _F	—	1.0 1.25	V	I _F = 100mA I _F = 200mA
Reverse Current @ Rated DC Blocking Voltage (Note 7)	I _R	—	100 15	nA μA	T _J = 25°C T _J = 100°C
Total Capacitance	C _T	—	5.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	50	ns	I _F = I _R = 30mA, I _{rr} = 0.1 x I _R , R _L = 100Ω

Notes: 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>. I_{FM}, I_O are valid provided that terminals are kept at ambient temperature.
7. Short duration pulse test used to minimize self-heating effect.

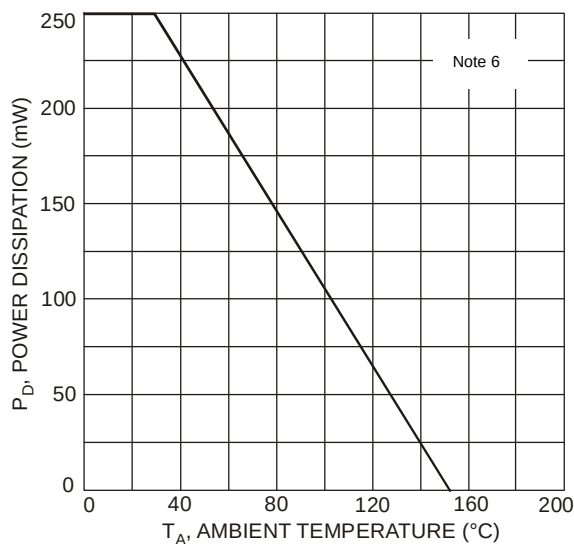


Fig. 1 Power Derating Curve

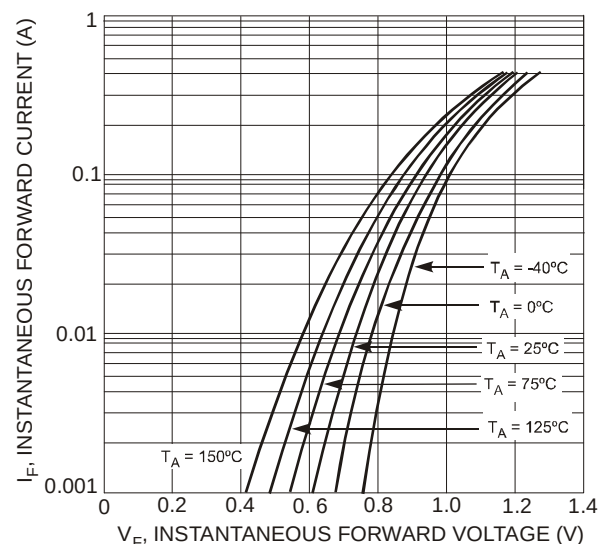


Fig. 2 Typical Forward Characteristics

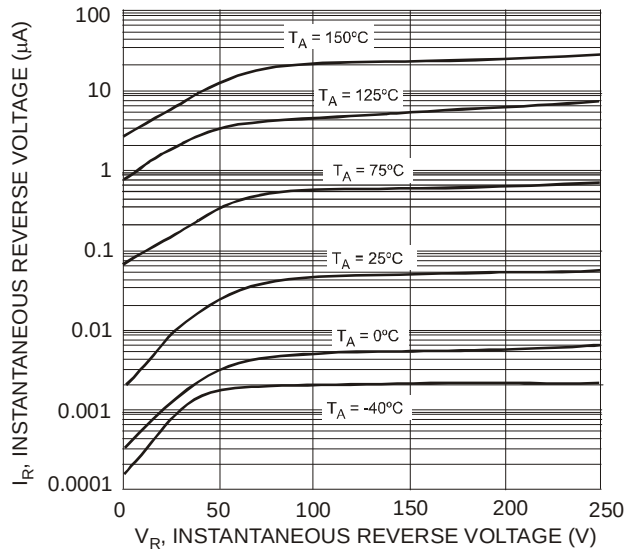


Fig. 3 Typical Reverse Characteristics

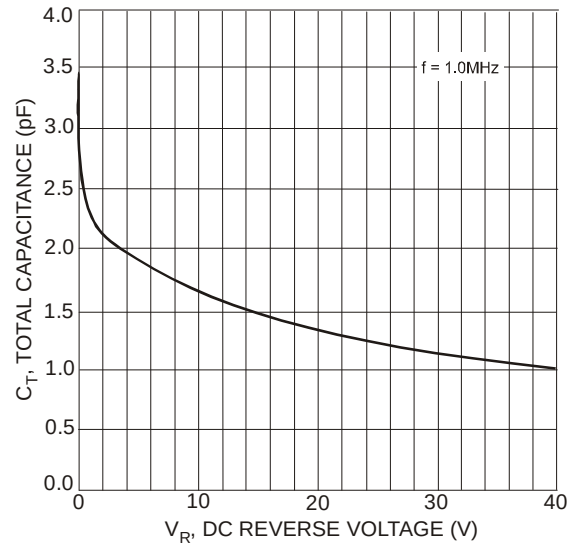
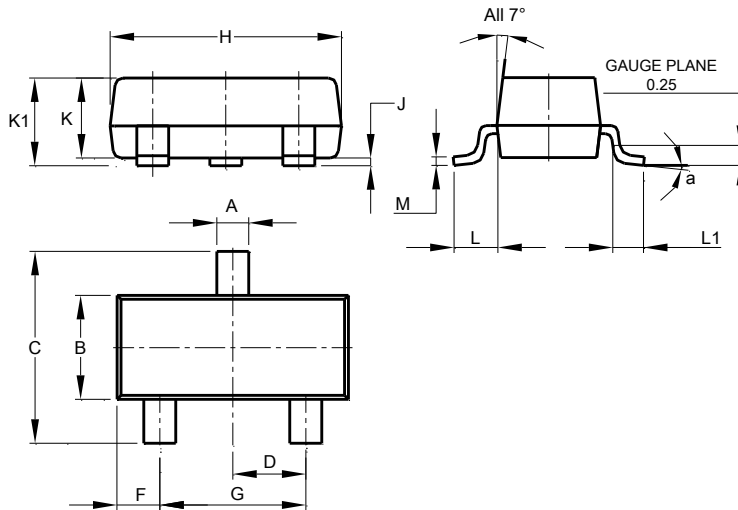


Fig. 4 Total Capacitance vs. Reverse Voltage

Package Outline Dimensions

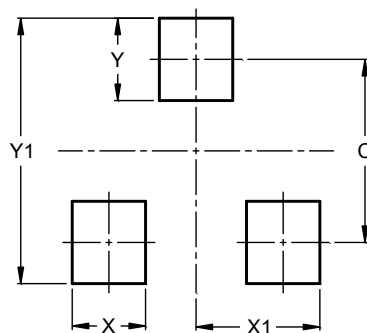
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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